

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

JUN 3 0 2008

Application No.: 10/647,297

Group Art Unit: 1794

Filing Date: August 26, 2003

Examiner: Hai Vo

Applicants: Hyun HUH et al.

Title: POLISHING PAD CONTAINING EMBEDDED LIQUID  
MICROELEMENTS AND METHOD OF  
MANUFACTURING THE SAME

Attorney Docket: 47881-000003/US

Customer Service Window  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314  
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June 30, 2008

~~DO NOT ENTER. 1111~~ OK TO ENTER

07/09/2008

Q.24.08

RCE - 7.18.08

SUPPLEMENTAL AMENDMENT UNDER 37 C.F.R. § 1.116

Sir:

In response to the Advisory Action mailed June 4, 2008, and the Final Office Action mailed January 18, 2008, the due date having been extended three (3) months to July 18, 2008, the following remarks are respectfully submitted in connection with the above-identified application.

Amendments to the Claims begins on page 2 of this Amendment.

Remarks begin on page 5 of this Amendment.

	Claims remaining after Amendment		Highest number previously paid for		Present extra
Total	14	-	31	=	0
Independent	1	-	3	=	0